|   | Туре | L#  | Hits  | Search Text   | DBs   | Time Stamp          | C<br>o<br>m<br>m | ef<br>in | Er |
|---|------|-----|-------|---|---|---------------------|------------------|----------|----|
| 1 | BRS  | L15 | 23960 | etch\$3 and ("solder bump" or bump or solder or C4)         | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>10:12 |                  |          | 0  |
| 2 | BRS  | L22 | 3862  | 15 and 438/\$.ccls.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>10:14 |                  |          | 0  |
| 3 | BRS  | L29 | 1005  | 15 and 216/\$.ccls.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>10:14 |                  |          | 0  |
| 4 | BRS  | L36 | 2134  | @pd <=20000531 and 22                                       | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>10:14 |                  |          | 0  |
| 5 | BRS  | L43 | 497   | (rotat\$3 same (wafer or semeiconductor or article)) and 15 | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>11:44 |                  |          | 0  |
| 6 | BRS  | L50 | 134   | 43 and 438/\$.ccls.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>11:55 |                  |          | 0  |
| 7 | BRS  | L57 | 26    | 43 and 216/\$.ccls.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>11:55 |                  |          | 0  |
| 8 | BRS  | L64 | 73    | @pd <=20000531 and 50                                       | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>12:01 |                  |          | 0  |

|    | Туре | L#   | Hits | Search Text   | DBs   | Time Stamp                   | o<br>m<br>m | ef<br>in | Er<br>ro<br>rs |
|----|------|------|------|---|---|------------------------------|-------------|----------|----------------|
| 9  | BRS  | L71  | 19   | @pd <=20000531 and 57   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>12:01          |             |          | 0              |
| 10 | BRS  | L78  | 64   | 64 not 71   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>10:45          |             |          | 0              |
| 11 | BRS  | L85  | 152  | rotat\$3 same (wafer or semeiconductor or article) same (sequential\$3 or continuous\$3 or complet\$3) and 15 | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>11: <b>4</b> 7 |             | •        | 0              |
| 12 | BRS  | L92  | 68   | 85 and 438/\$.ccls.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>11:58          |             |          | 0              |
| 13 | BRS  | L99  | 15   | 85 and 216/\$.ccls.   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>11:55          |             | •        | 0              |
| 14 | BRS  | L106 | .61  | 92 not 99   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>11:58          |             |          | 0              |
| 15 | BRS  | L113 | 0    | @pd <=20000531 and "61"   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>12:01          |             |          | 0              |
| 16 | BRS  | L120 | 0    | @pd <=20000531 and "61"   | USPAT;<br>US-PGPUB;<br>EPO: JPO;<br>DERWENT;<br>IBM_TDB | 2002/10/10<br>12·01          |             |          | 0              |